Vorläufige Daten
preliminary data

IGBT-Wechselrichter / IGBT-inverter

Höchstzulässige Werte / maximum rated values

Kollektor-Emitter-Sperrspannung collector-emitter voltage	T_{vj} = 25°C T_{vj} = -25°C	V_{CES}	3300 3300	V
Kollektor-Dauergleichstrom DC-collector current	T_C = 80°C T_C = 25°C	$I_{C\ nom}$ I_C	200 330	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	t_P = 1 ms, T_C = 80°C	I_{CRM}	400	A
Gesamt-Verlustleistung total power dissipation	T_C = 25°C	P_{tot}	2,20	kW
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/-20	V

Charakteristische Werte / characteristic values

			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	I_C = 200 A, V_{GE} = 15 V, T_{vj} = 25°C I_C = 200 A, V_{GE} = 15 V, T_{vj} = 125°C	$V_{CE\ sat}$		3,40 4,30	4,25 5,00	V V
Gate-Schwellenspannung gate threshold voltage	I_C = 20,0 mA, V_{CE} = V_{GE}, T_{vj} = 25°C	V_{GEth}	4,2	5,1	6,0	V
Gateladung gate charge	V_{GE} = -15 V ... +15 V, V_{CE} = 1800V	Q_G		4,00		µC
Interner Gatewiderstand internal gate resistor	T_{vj} = 25°C	R_{Gint}		2,5		Ω
Eingangskapazität input capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V	C_{ies}		25,0		nF
Rückwirkungskapazität reverse transfer capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V	C_{res}		1,40		nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	V_{CE} = 3300 V, V_{GE} = 0 V, T_{vj} = 25°C	I_{CES}			5,0	mA
Gate-Emitter Reststrom gate-emitter leakage current	V_{CE} = 0 V, V_{GE} = 20 V, T_{vj} = 25°C	I_{GES}			400	nA
Einschaltverzögerungszeit (ind. Last) turn-on delay time (inductive load)	I_C = 200 A, V_{CE} = 1800 V V_{GE} = ±15 V, R_{Gon} = 5,6 Ω, C_{GE} = 33,0 nF, T_{vj} = 25°C V_{GE} = ±15 V, R_{Gon} = 5,6 Ω, C_{GE} = 33,0 nF, T_{vj} = 125°C	$t_{d\ on}$		0,28 0,28		µs µs
Anstiegszeit (induktive Last) rise time (inductive load)	I_C = 200 A, V_{CE} = 1800 V V_{GE} = ±15 V, R_{Gon} = 5,6 Ω, C_{GE} = 33,0 nF, T_{vj} = 25°C V_{GE} = ±15 V, R_{Gon} = 5,6 Ω, C_{GE} = 33,0 nF, T_{vj} = 125°C	t_r		0,18 0,20		µs µs
Abschaltverzögerungszeit (ind. Last) turn-off delay time (inductive load)	I_C = 200 A, V_{CE} = 1800 V V_{GE} = ±15 V, R_{Goff} = 7,5 Ω, C_{GE} = 33,0 nF, T_{vj} = 25°C V_{GE} = ±15 V, R_{Goff} = 7,5 Ω, C_{GE} = 33,0 nF, T_{vj} = 125°C	$t_{d\ off}$		1,55 1,70		µs µs
Fallzeit (induktive Last) fall time (inductive load)	I_C = 200 A, V_{CE} = 1800 V V_{GE} = ±15 V, R_{Goff} = 7,5 Ω, C_{GE} = 33,0 nF, T_{vj} = 25°C V_{GE} = ±15 V, R_{Goff} = 7,5 Ω, C_{GE} = 33,0 nF, T_{vj} = 125°C	t_f		0,20 0,20		µs µs
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	I_C = 200 A, V_{CE} = 1800 V, L_S = 70 nH V_{GE} = ±15 V, R_{Gon} = 5,6 Ω, C_{GE} = 33,0 nF, T_{vj} = 25°C V_{GE} = ±15 V, R_{Gon} = 5,6 Ω, C_{GE} = 33,0 nF, T_{vj} = 125°C	E_{on}		235 365		mJ mJ
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	I_C = 200 A, V_{CE} = 1800 V, L_S = 70 nH V_{GE} = ±15 V, R_{Goff} = 7,5 Ω, C_{GE} = 33,0 nF, T_{vj} = 25°C V_{GE} = ±15 V, R_{Goff} = 7,5 Ω, C_{GE} = 33,0 nF, T_{vj} = 125°C	E_{off}		215 255		mJ mJ
Kurzschlußverhalten SC data	t_P ≤ 10 µs, V_{GE} ≤ 15 V T_{vj}≤125°C, V_{CC} = 2500 V, V_{CEmax} = V_{CES} -L_{sCE} ·di/dt	I_{SC}		1000		A
Innerer Wärmewiderstand thermal resistance, junction to case	pro IGBT per IGBT	R_{thJC}			57,0	K/kW
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro IGBT / per IGBT λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		49,0		K/kW

prepared by: Jürgen Biermann	date of publication: 2003-6-12
approved by: Christoph Lübke	revision: 2.0

Vorläufige Daten
preliminary data

Diode-Wechselrichter / diode-inverter

Höchstzulässige Werte / maximum rated values

Periodische Spitzensperrspannung repetitive peak reverse voltage	T_{vj} = 25°C T_{vj} = -25°C	V_{RRM}	3300 3300	V
Dauergleichstrom DC forward current		I_F	200	A
Periodischer Spitzenstrom repetitive peak forward current	t_P = 1 ms	I_{FRM}	400	A
Grenzlastintegral I²t - value	V_R = 0 V, t_P = 10 ms, T_{vj} = 125°C	I²t	14,0	kA²s
Spitzenverlustleistung maximum power dissipation	T_{vj} = 125°C	P_{RQM}	400	kW
Mindesteinschaltdauer minimum turn-on time		$t_{Fon\ min}$	10,0	µs

Charakteristische Werte / characteristic values

			min.	typ.	max.	
Durchlassspannung forward voltage	I_F = 200 A, V_{GE} = 0 V, T_{vj} = 25°C I_F = 200 A, V_{GE} = 0 V, T_{vj} = 125°C	V_F		2,80 2,80	3,50 3,50	V V
Rückstromspitze peak reverse recovery current	I_F = 200 A, - di_F/dt = 1100 A/µs V_R = 1800 V, V_{GE} = -15 V, T_{vj} = 25°C V_R = 1800 V, V_{GE} = -15 V, T_{vj} = 125°C	I_{RM}		275 325		A A
Sperrverzögerungsladung recovered charge	I_F = 200 A, -di_F/dt = 1100 A/µs V_R = 1800 V, V_{GE} = -15 V, T_{vj} = 25°C V_R = 1800 V, V_{GE} = -15 V, T_{vj} = 125°C	Q_r		120 220		µC µC
Abschaltenergie pro Puls reverse recovery energy	I_F = 200 A, -di_F/dt = 1100 A/µs V_R = 1800 V, V_{GE} = -15 V, T_{vj} = 25°C V_R = 1800 V, V_{GE} = -15 V, T_{vj} = 125°C	E_{rec}		125 255		mJ mJ
Innerer Wärmewiderstand thermal resistance, junction to case	pro Diode per diode	R_{thJC}			110	K/kW
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Diode / per diode λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		93,0		K/kW

Vorläufige Daten
preliminary data

Modul / module

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min.	V_{ISOL}		6,0		kV
Teilentladungs Aussetzspannung partial discharge extinction voltage	RMS, f = 50 Hz, Q_{PD} ≤ 10 pC (acc. to IEC 1287)	V_{ISOL}		2,6		kV
Kollektor-Emitter-Gleichsperrspannung DC stability	T_{vj} = 25°C, 100 fit	$V_{CE\ D}$		1800		V
Material Modulgrundplatte material of module baseplate				AlSiC		
Material für innere Isolation material for internal insulation				AlN		
Kriechstrecke creepage distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal			32,0 32,0		mm
Luftstrecke clearance distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal			19,0 19,0		mm
Vergleichszahl der Kriechwegbildung comparative tracking index		CTI		> 400		
			min.	typ.	max.	
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Modul / per module λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		16,0		K/kW
Modulinduktivität stray inductance module		L_{sCE}		58		nH
Modulleitungswiderstand, Anschlüsse - Chip module lead resistance, terminals - chip	T_C = 25°C, pro Zweig / per arm	$R_{CC'+EE'}$		0,78		mΩ
Höchstzulässige Sperrschichttemperatur maximum junction temperature		$T_{vj\ max}$			150	°C
Temperatur im Schaltbetrieb temperature under switching conditions		$T_{vj\ op}$	-40		125	°C
Lagertemperatur storage temperature		T_{stg}	-40		125	°C
Anzugsdrehmoment f. mech. Befestigung mounting torque	Schraube / screw M6	M	4,25	-	5,75	Nm
Anzugsdrehmoment f. elektr. Anschlüsse terminal connection torque	Schraube / screw M5	M	3,6	-	4,2	Nm
Gewicht weight		G		500		g

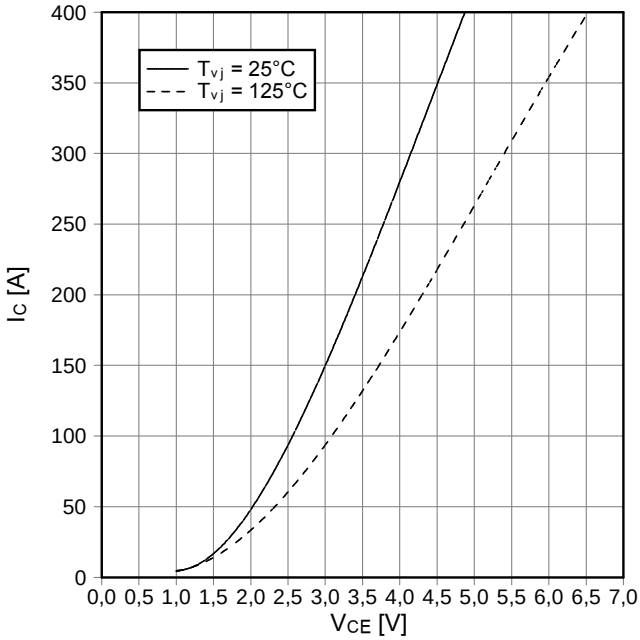
Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen technischen Erläuterungen.

This technical information specifies semiconductor devices but guarantees no characteristics. It is valid with the appropriate technical explanations.

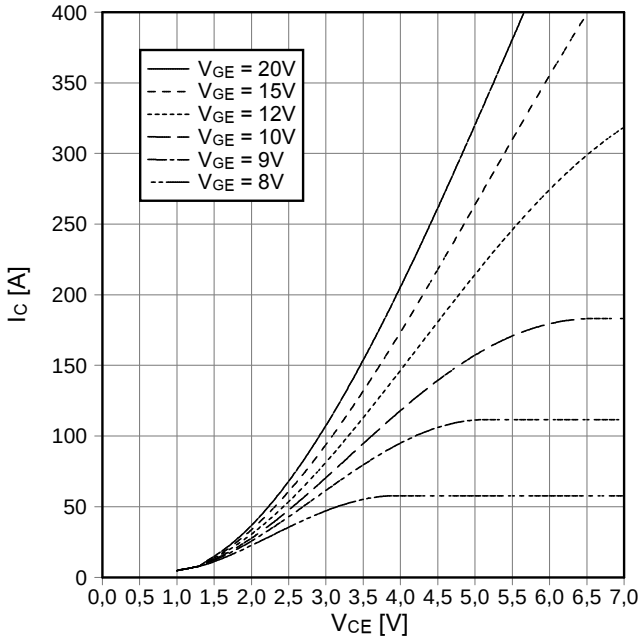
prepared by: Jürgen Biermann	date of publication: 2003-6-12
approved by: Christoph Lübke	revision: 2.0

Vorläufige Daten
preliminary data

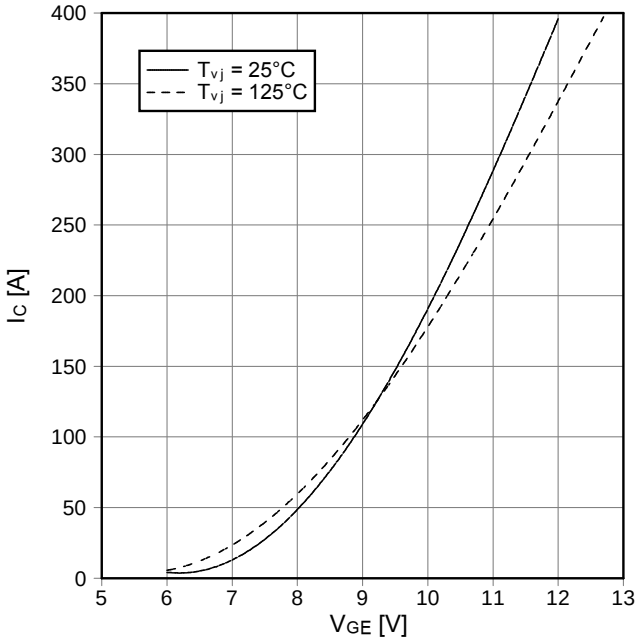
Ausgangskennlinie IGBT-Wechselr. (typisch)
output characteristic IGBT-inverter (typical)
$I_C = f(V_{CE})$
V_{GE} = 15 V



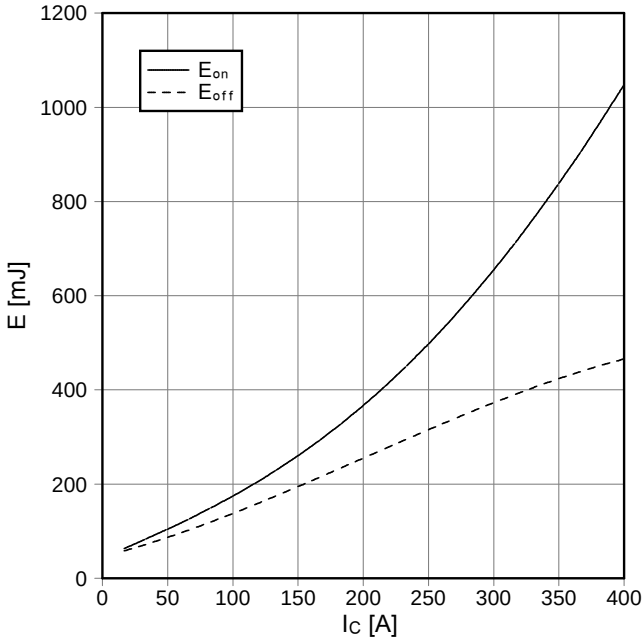
Ausgangskennlinienfeld IGBT-Wechselr. (typisch)
output characteristic IGBT-inverter (typical)
$I_C = f(V_{CE})$
T_{vj} = 125°C



Übertragungscharakteristik IGBT-Wechselr. (typisch)
transfer characteristic IGBT-inverter (typical)
$I_C = f(V_{GE})$
V_{CE} = 20 V



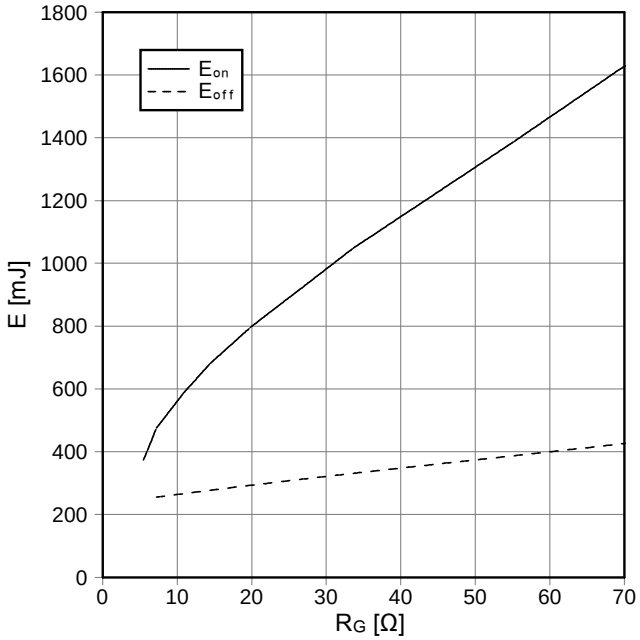
Schaltverluste IGBT-Wechselr. (typisch)
switching losses IGBT-inverter (typical)
$E_{on} = f(I_C)$, $E_{off} = f(I_C)$
V_{GE} = ±15 V, R_{Gon} = 5,6 Ω, R_{Goff} = 7,5 Ω, V_{CE} = 1800 V, T_{vj} = 125°C, C_{GE} = 33 nF



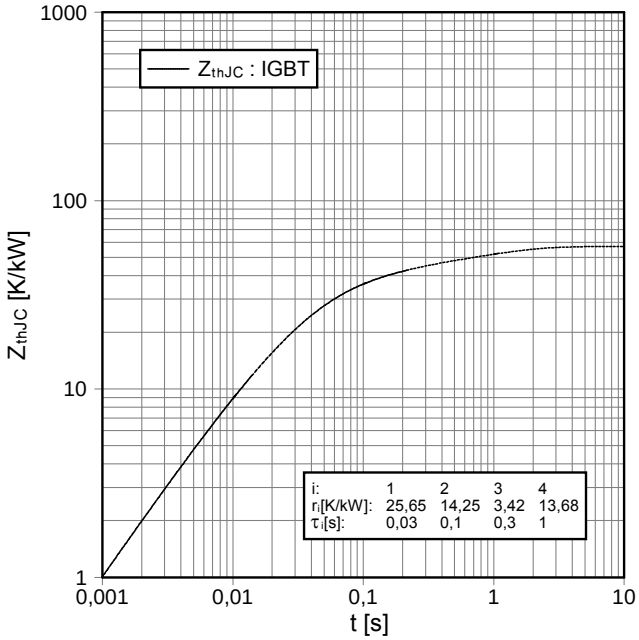
prepared by: Jürgen Biermann	date of publication: 2003-6-12
approved by: Christoph Lübke	revision: 2.0

Vorläufige Daten
preliminary data

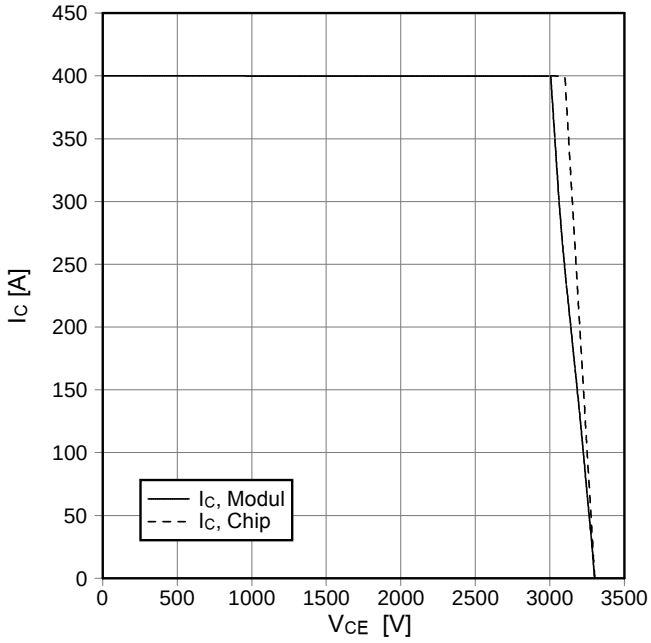
Schaltverluste IGBT-Wechselr. (typisch)
switching losses IGBT-Inverter (typical)
$E_{on} = f(R_G)$, $E_{off} = f(R_G)$
V_{GE} = ±15 V, I_C = 200 A, V_{CE} = 1800 V, T_{vj} = 125°C, C_{GE} = 33 nF



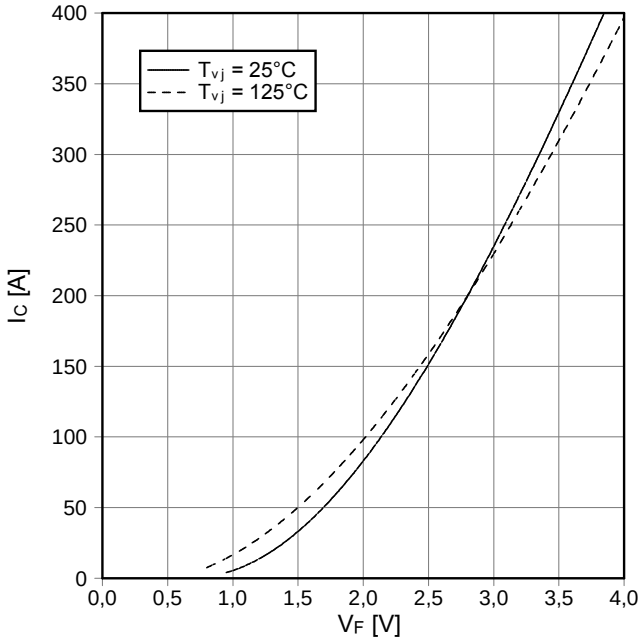
Transienter Wärmewiderstand IGBT-Wechselr.
transient thermal impedance IGBT-inverter
$Z_{thJC} = f(t)$



Sicherer Rückwärts-Arbeitsbereich IGBT-Wr. (RBSOA)
reverse bias safe operating area IGBT-inv. (RBSOA)
$I_C = f(V_{CE})$
V_{GE} = ±15 V, R_{Goff} = 7,5 Ω, T_{vj} = 125°C, C_{GE} = 33 nF



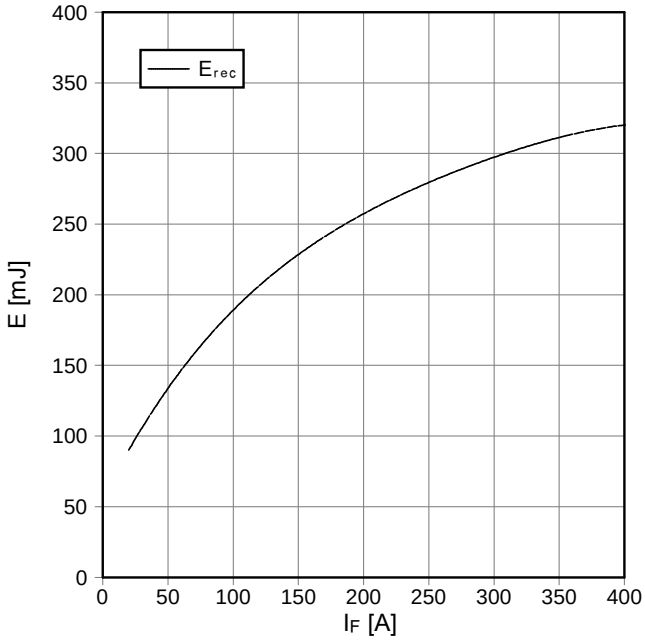
Durchlaßkennlinie der Diode-Wechselr. (typisch)
forward characteristic of diode-inverter (typical)
$I_F = f(V_F)$



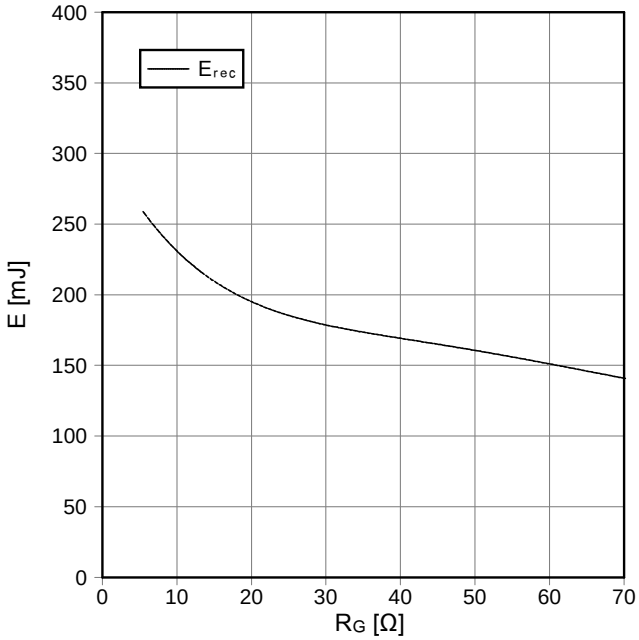
prepared by: Jürgen Biermann	date of publication: 2003-6-12
approved by: Christoph Lübke	revision: 2.0

Vorläufige Daten
preliminary data

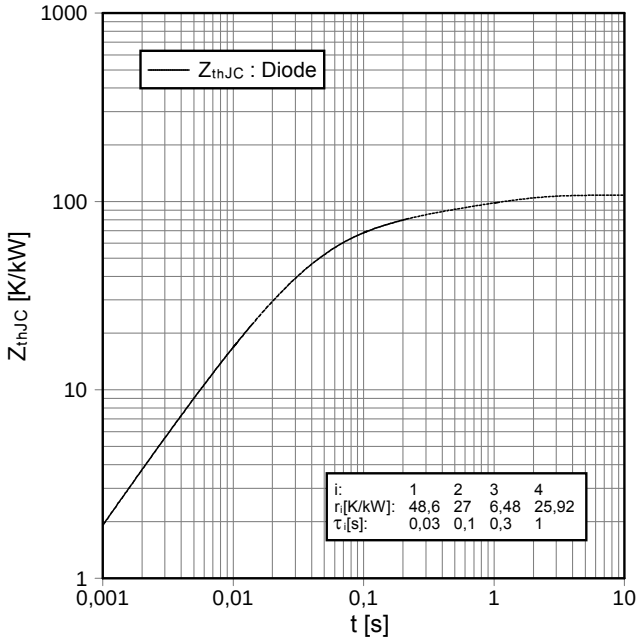
Schaltverluste Diode-Wechselr. (typisch)
switching losses diode-inverter (typical)
$E_{rec} = f(I_F)$
$R_{Gon} = 5{,}6\ \Omega$, $V_{CE} = 1800$ V, $T_{vj} = 125°C$



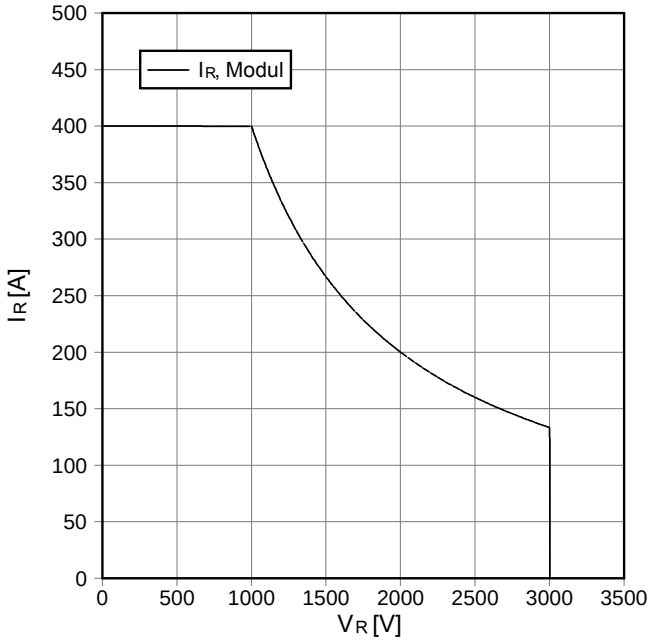
Schaltverluste Diode-Wechselr. (typisch)
switching losses diode-inverter (typical)
$E_{rec} = f(R_G)$
$I_F = 200$ A, $V_{CE} = 1800$ V, $T_{vj} = 125°C$



Transienter Wärmewiderstand Diode-Wechselr.
transient thermal impedance diode-inverter
$Z_{thJC} = f(t)$



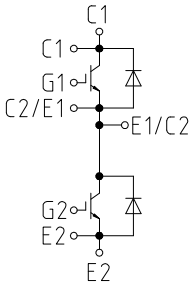
Sicherer Arbeitsbereich Diode-Wechselr. (SOA)
save operation area diode-inverter (SOA)
$I_R = f(V_R)$
$T_{vj} = 125°C$



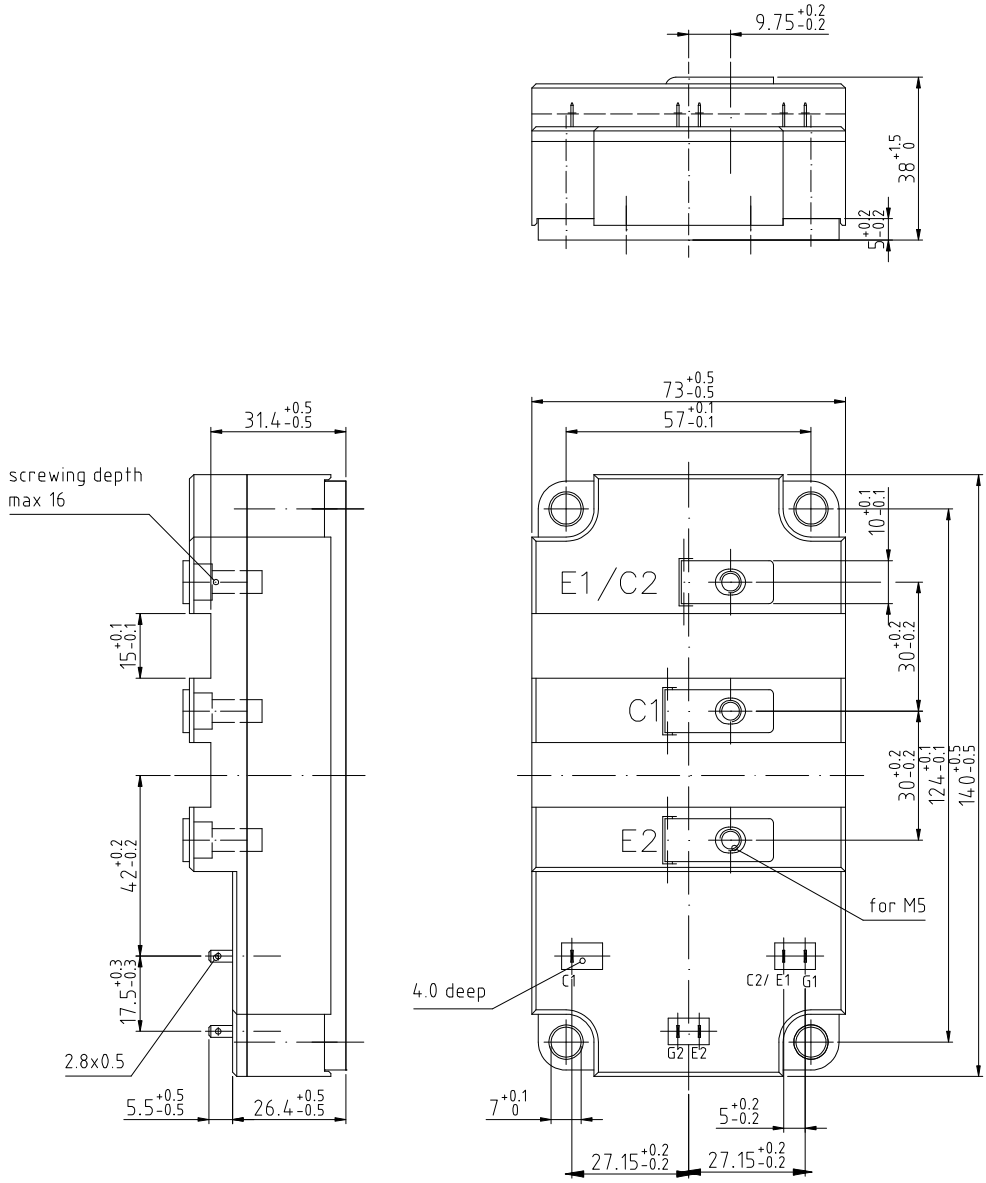
prepared by: Jürgen Biermann	date of publication: 2003-6-12
approved by: Christoph Lübke	revision: 2.0

Vorläufige Daten
preliminary data

Schaltplan / circuit diagram



Gehäuseabmessungen / package outlines



prepared by: Jürgen Biermann	date of publication: 2003-6-12
approved by: Christoph Lübke	revision: 2.0

Terms & Conditions of Usage

Attention
The present product data is exclusively subscribed to technically experienced staff. This Data Sheet is describing the specification of the products for which a warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its specifications. Changes to the Data Sheet are reserved.

You and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application. Should you require product information in excess of the data given in the Data Sheet, please contact your local Sales Office via "www.eupec.com / sales & contact".

Warning
Due to technical requirements the products may contain dangerous substances. For information on the types in question please contact your local Sales Office via "www.eupec.com / sales & contact".

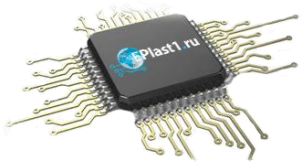
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.